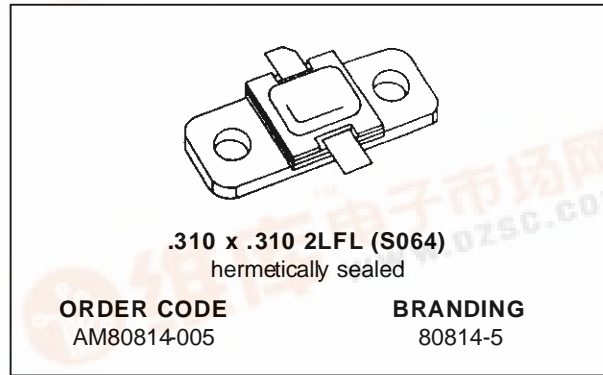




## AM80814-005

### RF & MICROWAVE TRANSISTORS L-BAND RADAR APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 5:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P<sub>OUT</sub> = 5.0 W MIN. WITH 8.5 dB GAIN

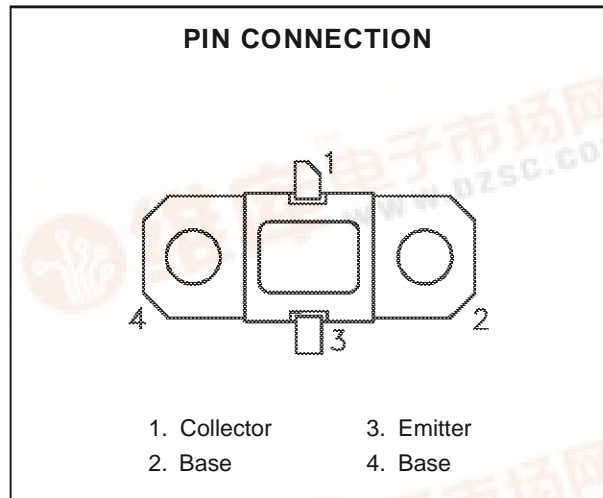


#### DESCRIPTION

The AM80814-005 device is a high power Class C transistor specifically designed for L-Band radar pulsed driver applications.

This device is capable of operation over a wide range of pulse widths, duty cycles and temperatures and is capable of withstanding 5:1 output VSWR at rated RF conditions. Low thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The AM80814-005 is supplied in the IMPAC™ Hermetic Metal/Ceramic package with internal Input/Output matching structures.



#### ABSOLUTE MAXIMUM RATINGS (T<sub>case</sub> = 25°C)

Symbol	Parameter	Value	Unit
P <sub>DISS</sub>	Power Dissipation* (T <sub>C</sub> ≤ 100°C)	23	W
I <sub>C</sub>	Device Current*	1.0	A
V <sub>CC</sub>	Collector-Supply Voltage*	28	V
T <sub>J</sub>	Junction Temperature (Pulsed RF Operation)	250	°C
T <sub>STG</sub>	Storage Temperature	- 65 to +200	°C

#### THERMAL DATA

R <sub>TH(j-c)</sub>	Junction-Case Thermal Resistance*	6.5	°C/W
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\*Applies only to rated RF amplifier operation

# AM80814-005

## ELECTRICAL SPECIFICATIONS (T<sub>case</sub> = 25°C)

### STATIC

Symbol	Test Conditions		Value			Unit
			Min.	Typ.	Max.	
BV <sub>CBO</sub>	I <sub>C</sub> = 1mA	I <sub>E</sub> = 0mA	48	—	—	V
BV <sub>EBO</sub>	I <sub>E</sub> = 1mA	I <sub>C</sub> = 0mA	3.5	—	—	V
BV <sub>CER</sub>	I <sub>C</sub> = 5mA	R <sub>BE</sub> = 10Ω	48	—	—	V
I <sub>CES</sub>	V <sub>BE</sub> = 0V	V <sub>CE</sub> = 28V	—	—	500	mA
h <sub>FE</sub>	V <sub>CE</sub> = 5V	I <sub>C</sub> = 250mA	30	—	300	—

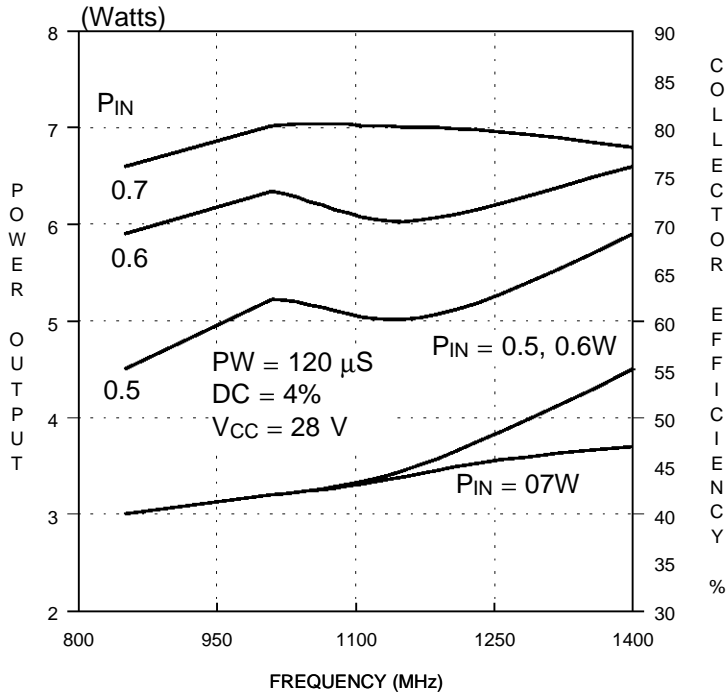
### DYNAMIC

Symbol	Test Conditions			Value			Unit
				Min.	Typ.	Max.	
P <sub>OUT</sub>	f = 850 — 1400MHz	P <sub>IN</sub> = 0.7W	V <sub>CC</sub> = 28V	5.0	5.7	—	W
η <sub>c</sub>	f = 850 — 1400MHz	P <sub>IN</sub> = 0.7W	V <sub>CC</sub> = 28V	35	40	—	%
G <sub>P</sub>	f = 850 — 1400MHz	P <sub>IN</sub> = 0.7W	V <sub>CC</sub> = 28V	8.5	9.0	—	dB

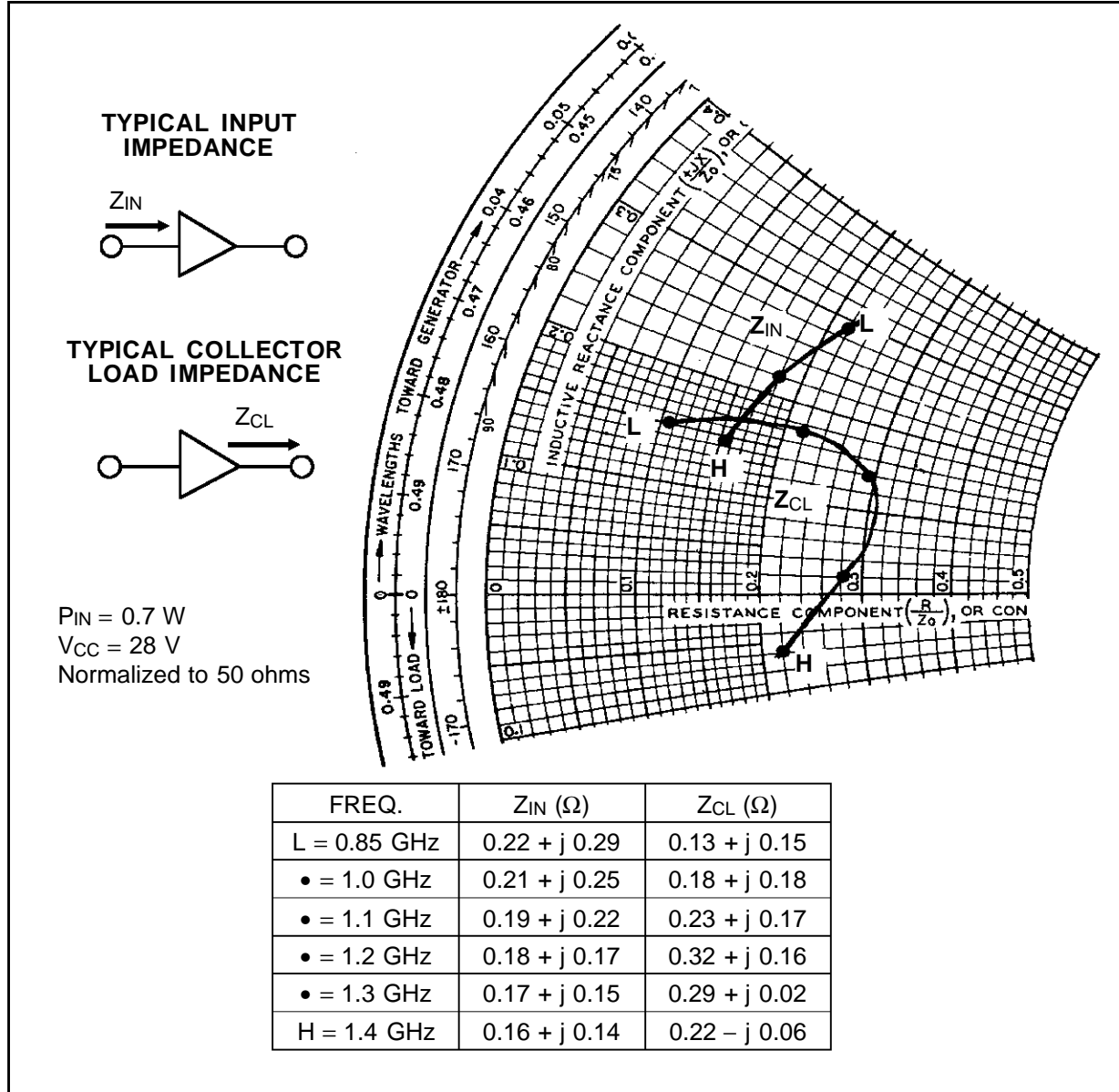
Note: Pulse Width = 120μS  
Duty Cycle = 4%

## TYPICAL PERFORMANCE

### POWER OUTPUT & COLLECTOR EFFICIENCY vs FREQUENCY

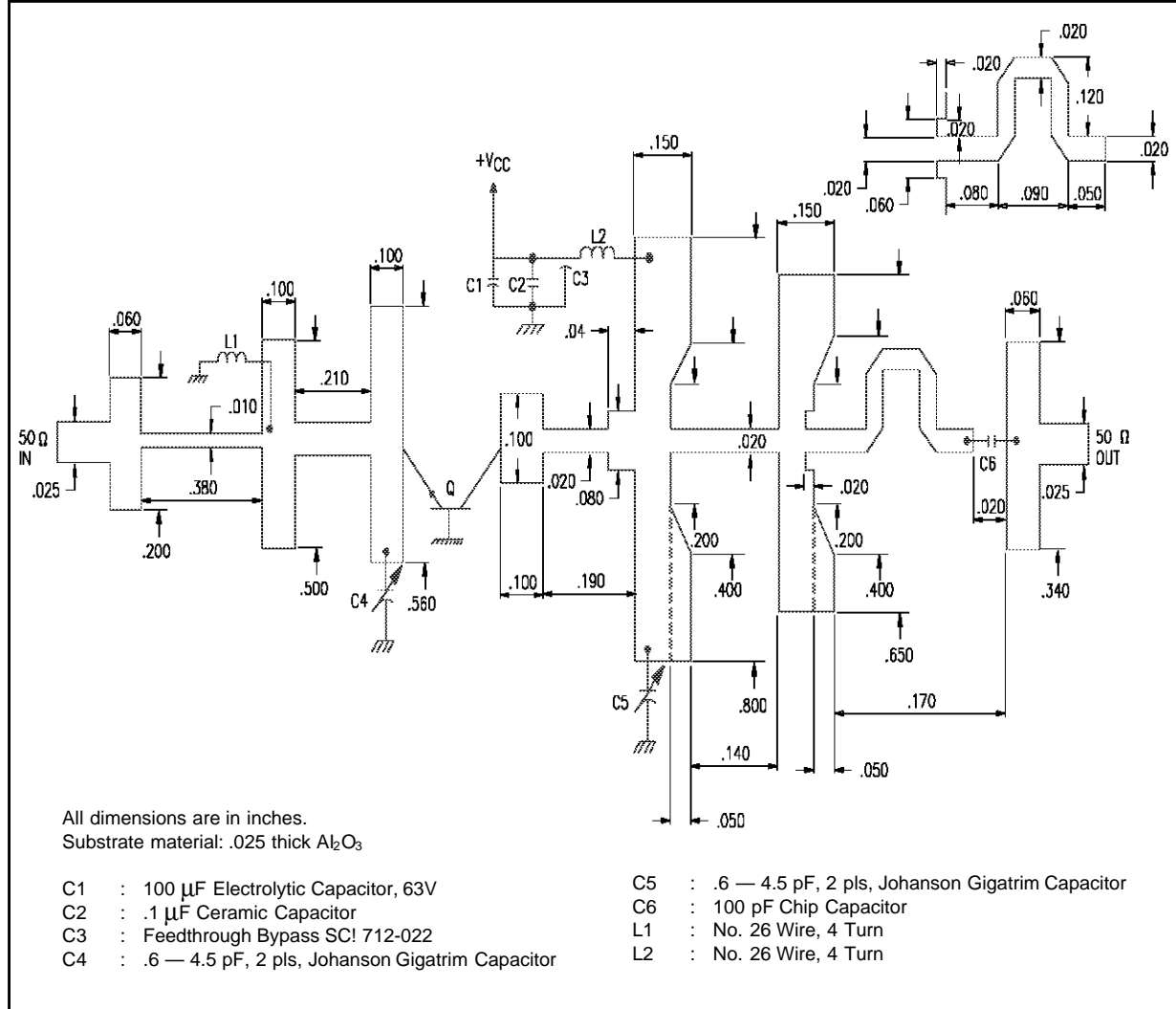


IMPEDANCE DATA



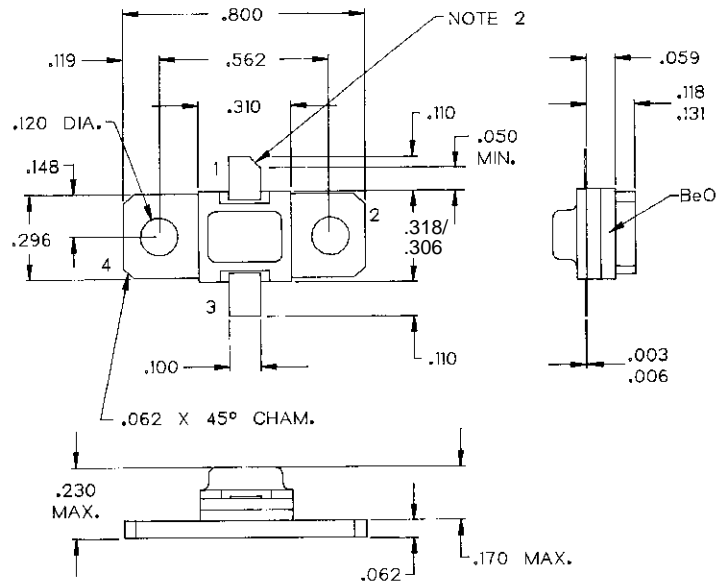
AM80814-005

TEST CIRCUIT



## PACKAGE MECHANICAL DATA

Ref.: Dwg. No.: J133100D



## NOTES:

1. ALL TOLERANCE  $\pm .010$  EXCEPT WHERE NOTED;  
DIMENSIONS IN INCHES.
2. COLLECTOR LEAD CHAMFER 45° NOM. X .040 NOM.

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